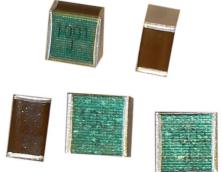
2500 & 4000 Volt RF Capacitors for Medical Imaging Coils, Plasma Generators, VHF/UHF Power Amplifiers and Antenna Tuning with Nonmagnetic Option



Highlights

- No thermal cracking
- FR4 compatible and wave solderable
- Extremely high Q above 50 MHz
- Nonmagnetic option available
- Ultra stable: no change with (t), (V) and (f)
- Excellent for tuning and impedance matching
- High flashover level
- Withstands 2 mm bend test
- Better than porcelain

The flexible aluminum silicate dielectric eliminates cracking and permits soldering to 260 °C. These high voltage, RF capacitors need no voltage derating at temperatures up to 125 °C and voltages to 4000 Vdc. Exceptionally low ESR and superior thermal qualities set the MCH/MCHN chip capacitors apart from ordinary RF capacitors.

Applications

- MRI Coils
- RF Ablation Systems
- Transmitters
- RF Generators
- Antenna Tuning
- Lasers
- RF Power Amplifiers
- MRI Generators

Specifications

Capacitance Range & Rated Voltage	10 – 220 pF at 4kVdc and 270 – 1000 pF at 2500 Vdc (other ratings available)						
Capacitance Tolerance	±5% standard (±2% available)						
Operating Temperature Range	–55 °C to +125 °C (with no voltage derating)						
Case Size	3838 (9.7 x 9.7 mm)						
Temperature Characteristics	Temp. Coefficient Cap Drift						
	0 to +50 ppm/°C ±(0.05%+0.1 pF)						
Regulatory Information							

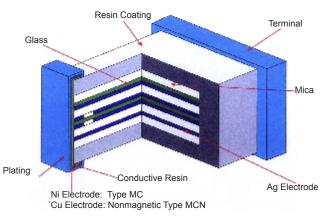
Engineering Design Kits

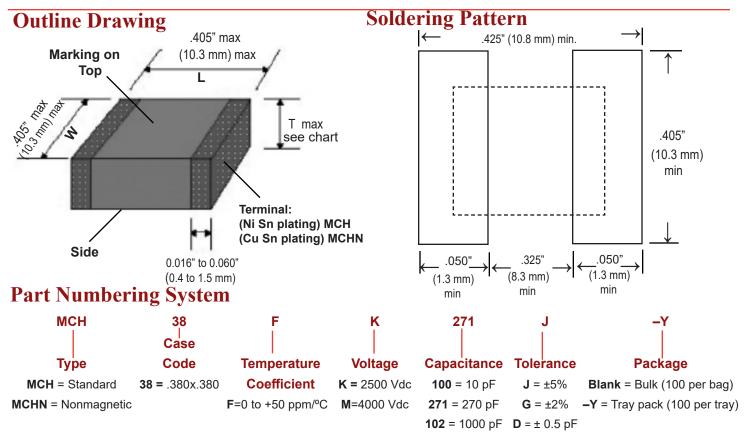
MCH2500VKIT8, MCH4000VKIT10 Nonmagnetic MCHN2500VKIT9, MCHN4000VKIT11



2500 V kits 5 each of 8 values 270 to 1000 pF 4000 V kits 5 each of 10 values 10 – 220 pF

High Q, Low ESR Multilayer Construction for RF Power Applications





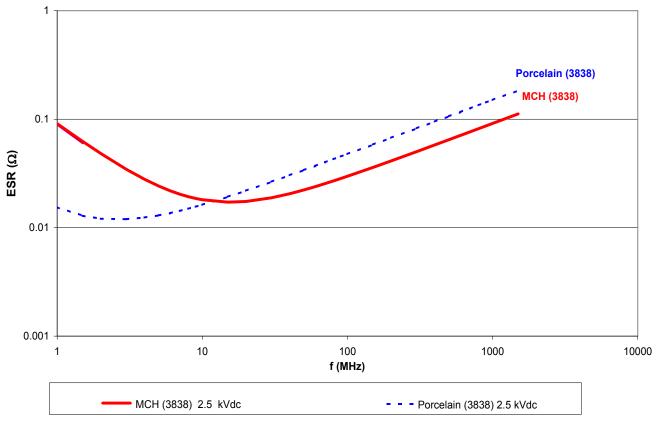
Ratings (additional ratings available)

Сар	Catalog	Voltage	Length	Width	T max
(pF)	Part Number*	(Vdc)	Inches (mm)	Inches (mm)	Inches (mm)
10	MCH38FM100D-Y	4000 Vdc			0.080 (2.03 mm)
12	MCH38FM120J-Y				
15	MCH38FM150J-Y				
18	MCH38FM180J-Y				
22	MCH38FM220J-Y				
27	MCH38FM270J-Y				
33	MCH38FM330J-Y				
39	MCH38FM390J-Y				
47	MCH38FM470J-Y				0.120 (3.05 mm)
56	MCH38FM560J-Y				
68	MCH38FM680J-Y		0.380 +0.025 / -0 (9.65 mm +0.65 /- 0)	0.380 +0.025 / -0 (9.65 mm +0.65 / -0)	
82	MCH38FM820J-Y				
100	MCH38FM101J-Y				
120	MCH38FM121J-Y				0.160 (4.06 mm)
150	MCH38FM151J-Y				
180	MCH38FM181J-Y				0.240 (6.10 mm)
220	MCH38FM221J-Y				0.2 10 (0.10 11111)
270	MCH38FK271J-Y	2500 Vdc			
330	MCH38FK331J-Y				0.160 (4.06 mm)
390	MCH38FK391J-Y				0.100 (4.00 11111)
470	MCH38FK471J-Y				
560	MCH38FK561J-Y				
680	MCH38FK681J-Y				0.240 (6.10 mm)
820	MCH38FK821J-Y				
1000	MCH38FK102J-Y				0.270 (6.86 mm)

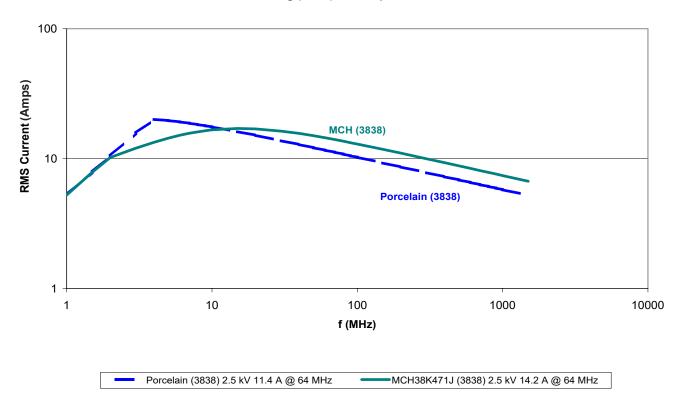
^{*}For nonmagnetic version change P/N prefix to MCHN

Typical Performance Data

ESR vs. Frequency for 470 pF

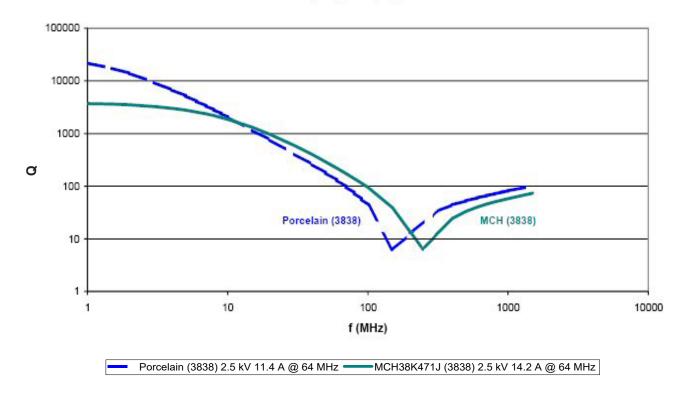


Current Rating (IRMS) for 470 pF at 60 °C Rise

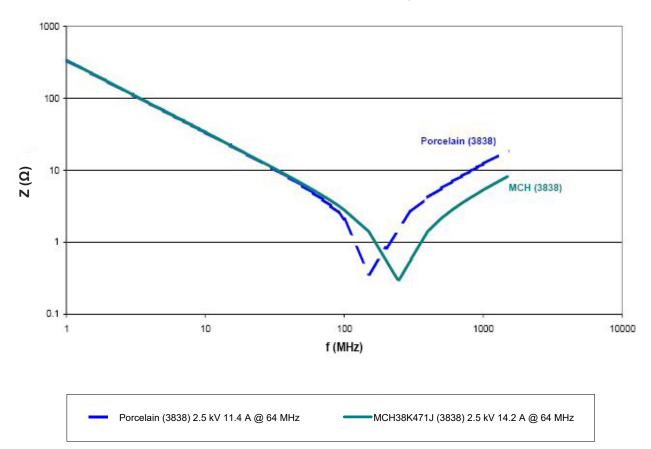


Typical Performance Data

Q vs. Frequency 470 pF @ 25 °C

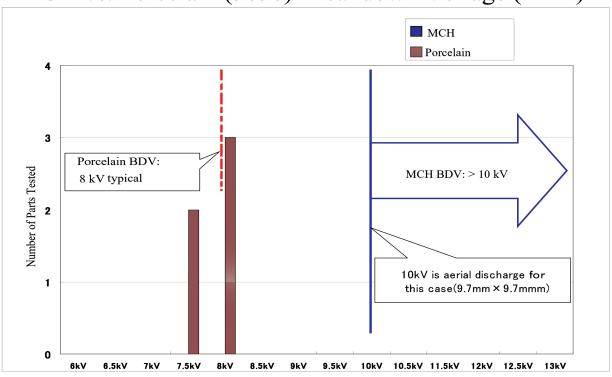


Impedance vs. Frequency for 470 pF @ 25 °C



Typical Performance Data

MCH vs. Porcelain (3838) Breakdown Voltage (BDV)



Environmental Specifications

Humidity (No Load): +40 °C ±2 °C @ 90%

to 95% RH, 500 hrs.

Measure after 24 hrs, cap is $\pm 3\%$ of initial, DF $\leq 150\%$ of original, IR $3x10^4 M\Omega$,

no visual damage

Storage Method: Store at 0 to +40 °C at

≤60% RH, use within 6 months of receipt, if 6 months is exceeded,

check solderability

Electrical Specifications

Dielectric Strength: 2500 Vdc:

1.5 x Rated Voltage for 5 seconds

4000 Vdc:

1.2 x Rated Voltage

for 5 seconds

Dissipation Factor (DF): ≤0.1% @ 1 MHz and

≤5 Vrms

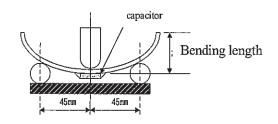
Insulation Resistance: 100K $M\Omega$ minimum

@ 500 Vdc ±10%

Mechanical Specifications

Bending Test:

Mount the capaci-tor as shown below and press the ram bar until a 2.0 mm deflection is achieved. There will be no visual damage and the capacitors will meet the limits of methods JIS 5102 8.11 and AEC-Q200-005 without cracking or visual damage.

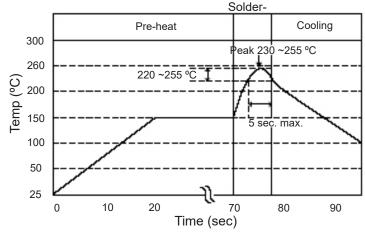


Soldering Specifications

Reflow Solder Profile

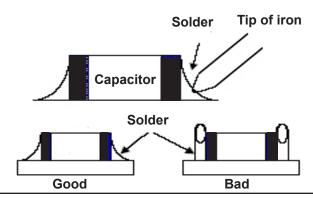
Soldering Cooling Pre-heat 300 Peak 230~260 °C 260 220 ~260 °C 200 150 100 50 25 50 30 150 180 200 Time (sec)

Wave Solder Profile



Hand Soldering Method

- SnPb or SnAgCu recommended solder
- Do not use strong acid type flux with RM or RMS
- Soldering iron tip temperature should be 280 °C to 350 °C ≤ 5 sec.
- 80 Watt iron or less
- Iron tip should not touch chip terminals



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